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U.S. UTILITY Patent Application

PATENT NUMBER and
ISSUE DATE

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10087566	03/01/2002	428	469	1775	Xu

**APPLICANTS: Furo Masahiro; Osanai Hideyo;

**CONTINUING DATA VERIFIED:
None LX

** FOREIGN APPLICATIONS VERIFIED:
JAPAN 056106/2001 03/01/2001
JAPAN 0-6579/2002 01/25/2002 LX

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed	<input checked="" type="checkbox"/> yes <input type="checkbox"/> no	ATTORNEY DOCKET NO
35 USC 119 conditions met	<input checked="" type="checkbox"/> yes <input type="checkbox"/> no	134.142
Verified and Acknowledged Examiners's initials <i>Wing Xu</i>		
TITLE : Insulating substrate boards for semiconductor and power modules		

U.S. DEPT. OF COMM. PAT. & TM-PTO-436L (Rev. 12-95)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
Assistant Examiner		Total Claims	Print Claim for O.G.
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg.
Primary Examiner		Print Fig.	
PREPARED FOR ISSUE		Application Examiner	
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